

# **NCE N-Channel Super Trench II Power MOSFET**

## **Description**

The series of devices uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{\text{DS(ON)}}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

# **Application**

- DC/DC Converter
- ●Ideal for high-frequency switching and synchronous rectification

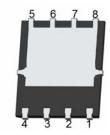
### **General Features**

- $V_{DS}$  =100V, $I_{D}$  =75A  $R_{DS(ON)}$ =7.0m $\Omega$  , typical@  $V_{GS}$ =10V  $R_{DS(ON)}$ =9.2m $\Omega$  , typical@  $V_{GS}$ =4.5V
- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 150 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!

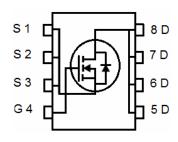
#### **DFN 5X6**





**Top View** 

**Bottom View** 



**Schematic Diagram** 

# **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
P078N10AG	NCEP078N10AG	DFN5X6-8L	-	-	-

## Absolute Maximum Ratings (T<sub>C</sub>=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	100	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous	I <sub>D</sub>	75	Α
Drain Current-Continuous(T <sub>C</sub> =100℃)	I <sub>D</sub> (100°C)	54	А
Pulsed Drain Current	I <sub>DM</sub>	300	А
Maximum Power Dissipation	P <sub>D</sub>	100	W
Derating factor		0.8	W/℃
Single pulse avalanche energy (Note 4)	E <sub>AS</sub>	420	mJ
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 150	$^{\circ}$

### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case Rajc 1.25 C/W
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Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

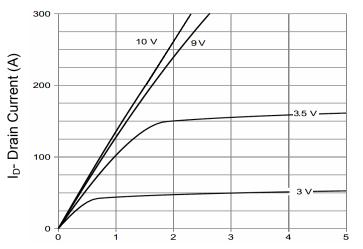
Parameter Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	100		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =100V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	1.2	1.7	2.2	V
Drain Source On State Registance	В	V <sub>GS</sub> =10V, I <sub>D</sub> =37.5A	-	7.0	7.8	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =37.5A	-	9.0	10.5	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =37.5A		60	-	S
Dynamic Characteristics (Note3)						
Input Capacitance	C <sub>lss</sub>	\/ F0\/\/ 0\/	-	3450	-	pF
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ =50V, $V_{GS}$ =0V, F=1.0MHz	-	305	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	r=1.0lvln2	-	8	-	pF
Switching Characteristics (Note 3)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	16	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =50 $V$ , $I_{D}$ =37.5 $A$	-	11	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{G}$ =1.6 $\Omega$	-	35	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	9	-	nS
Total Gate Charge	Qg	\/ -50\/  -27.54	-	70	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}=50V, I_{D}=37.5A,$ $V_{GS}=10V$	-	14.5	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	16.8	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 2)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =37.5A	-	-	1.2	V
Diode Forward Current	Is		-	-	75	Α
Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25^{\circ}C$ , $I_F = 37.5A$	-	60	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	106	-	nC

## Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 3. Guaranteed by design, not subject to production
- 4. EAS condition : Tj=25  $^{\circ}\text{C}$  ,V  $_{DD}$  =50 V ,V  $_{G}$  =10 V ,L=0.25 mH ,Rg=25  $\Omega$

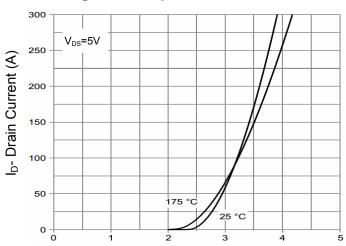


## **Typical Electrical and Thermal Characteristics**



Vds Drain-Source Voltage (V)

**Figure 1 Output Characteristics** 



Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

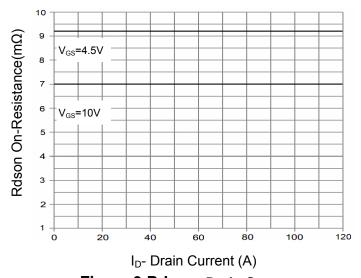
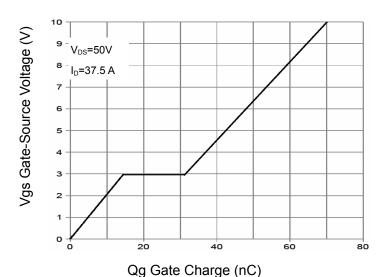


Figure 3 Rdson- Drain Current



**Figure 4 Gate Charge** 

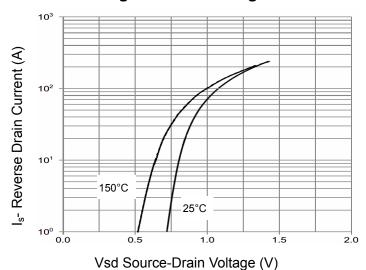


Figure 5 Source- Drain Diode Forward

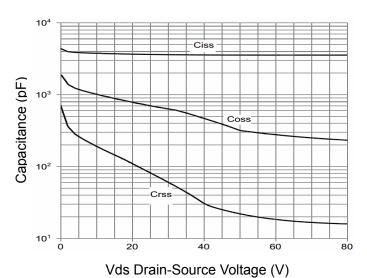
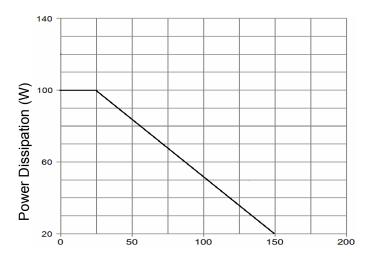
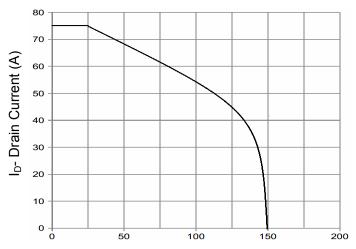


Figure 6 Capacitance vs Vds





T<sub>J</sub>-Junction Temperature(°C) Figure 7 Power De-rating



T<sub>J</sub>-Junction Temperature (°C) Figure 9 Current De-rating

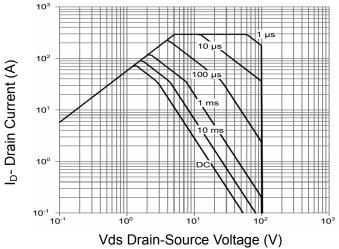


Figure 8 Safe Operation Area

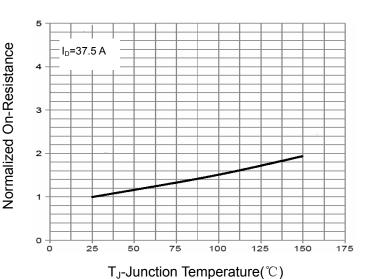
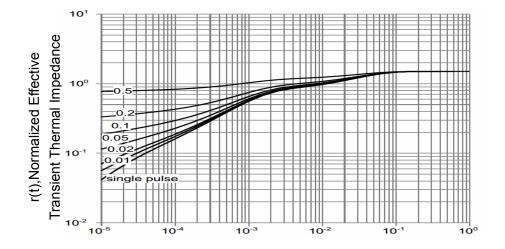


Figure 10 Rdson-Junction Temperature

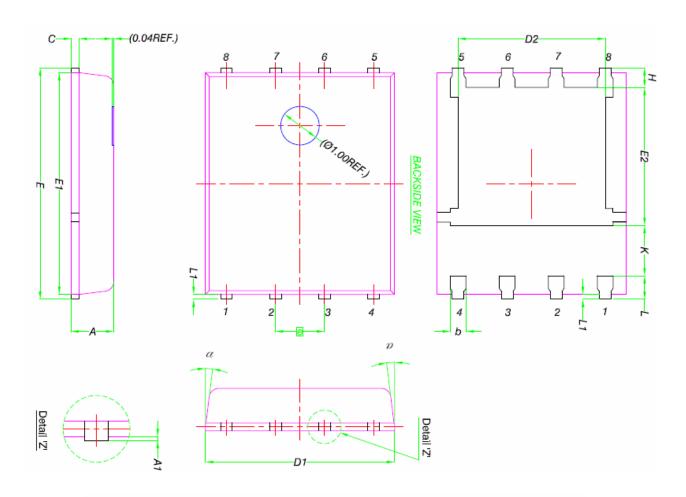


Square Wave Pluse Duration(sec)

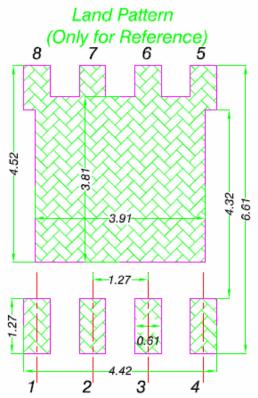
**Figure 11 Normalized Maximum Transient Thermal Impedance** 



# **DFN5X6-8L Package Information**



	MILLIMETERS			
DIM.	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
A1	0	-	0.05	
b	0.33	0.41	0.51	
С	0.20	0.25	0.30	
D1	4.80	4.90	5.00	
D2	3.61	3.81	3.96	
Ε	5.90	6.00	6.10	
E1	5.70	5.75	5.80	
E2	3.38	3.58	3.78	
е		1.27 BSC		
Н	0.41	0.51	0.61	
K	1.10	-	-	
L	0.51	0.61	0.71	
L1	0.06	0.13	0.20	
α	0°	-	12°	





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